

### **Description**

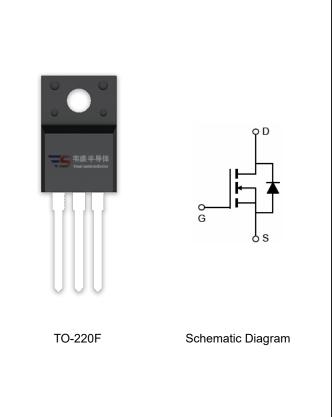
The VST25N1020 uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of  $R_{\text{DS(ON)}}$  and  $Q_g$ . This device is ideal for high-frequency switching and synchronous rectification.

#### **General Features**

- $V_{DS}$  =250V, $I_D$  =15A  $R_{DS(ON)}$ =102m $\Omega$  (typical) @  $V_{GS}$ =10V
- Excellent gate charge x R<sub>DS(on)</sub> product(FOM)
- Very low on-resistance R<sub>DS(on)</sub>
- 175 °C operating temperature
- Pb-free lead plating

### **Application**

- LED backlighting
- Ideal for high-frequency switching and synchronous rectification



**Package Marking and Ordering Information** 

| Device Marking | Device     | Device Package | Reel Size | Tape width | Quantity |
|----------------|------------|----------------|-----------|------------|----------|
| VST25N1020-TF  | VST25N1020 | TO-220F        | -         | -          | -        |

Absolute Maximum Ratings (T<sub>A</sub>=25°Cunless otherwise noted)

| Parameter  | Symbol                 | Limit      | V V A A |  |
|--|------------------------|------------|---------|--|
| Drain-Source Voltage                             | V <sub>DS</sub>        | 250        |         |  |
| Gate-Source Voltage                              | V <sub>GS</sub>        | ±20        |         |  |
| Drain Current-Continuous                         | I <sub>D</sub>         | 15         |         |  |
| Drain Current-Continuous(T <sub>C</sub> =100°C)  | I <sub>D</sub> (100°C) | 10.5       |         |  |
| Pulsed Drain Current                             | I <sub>DM</sub>        | 60         | А       |  |
| Maximum Power Dissipation                        | P <sub>D</sub>         | 30         | W       |  |
| Derating factor                                  |                        | 0.20       | W/°C    |  |
| Single pulse avalanche energy (Note 5)           | E <sub>AS</sub>        | 180        | mJ      |  |
| Operating Junction and Storage Temperature Range | $T_{J}$ , $T_{STG}$    | -55 To 175 | °C      |  |



### **Thermal Characteristic**

| Thermal Résistance, Junction-to-Case <sup>(Note 2)</sup> | Rejc | 5 | °C/W | 1 |
|--|------|---|------|---|
|--|------|---|------|---|

# Electrical Characteristics (T<sub>A</sub>=25°C unless otherwise noted)

| Parameter                          | Symbol              | Condition   | Min | Тур  | Max  | Unit |
|------------------------------------|---------------------|---|-----|------|------|------|
| Off Characteristics                | ·                   |   |     |      |      |      |
| Drain-Source Breakdown Voltage     | BV <sub>DSS</sub>   | V <sub>GS</sub> =0V I <sub>D</sub> =250μA                                 | 250 | -    | -    | V    |
| Zero Gate Voltage Drain Current    | I <sub>DSS</sub>    | V <sub>DS</sub> =250V,V <sub>GS</sub> =0V                                 | -   | -    | 1    | μΑ   |
| Gate-Body Leakage Current          | I <sub>GSS</sub>    | V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V                                 | -   | -    | ±100 | nA   |
| On Characteristics (Note 3)        |                     |   |     |      |      |      |
| Gate Threshold Voltage             | V <sub>GS(th)</sub> | $V_{DS}=V_{GS}$ , $I_{D}=250\mu A$  | 2.5 | 3.5  | 4.5  | V    |
| Drain-Source On-State Resistance   | R <sub>DS(ON)</sub> | V <sub>GS</sub> =10V, I <sub>D</sub> =15A                                 | -   | 102  | 110  | mΩ   |
| Forward Transconductance           | <b>g</b> Fs         | V <sub>DS</sub> =5V,I <sub>D</sub> =15A                                   | 20  | -    | -    | S    |
| Dynamic Characteristics (Note4)    |                     |   | •   | •    |      | •    |
| Input Capacitance                  | C <sub>lss</sub>    | V <sub>DS</sub> =125V,V <sub>GS</sub> =0V,                                | -   | 951  |      | PF   |
| Output Capacitance                 | C <sub>oss</sub>    |   | -   | 68   |      | PF   |
| Reverse Transfer Capacitance       | C <sub>rss</sub>    | F=1.0MHz  | -   | 2.4  |      | PF   |
| Switching Characteristics (Note 4) |                     |   | •   | •    |      | •    |
| Turn-on Delay Time                 | t <sub>d(on)</sub>  | $V_{DD}$ =125V, RL=8 $\Omega$<br>$V_{GS}$ =10V,R <sub>G</sub> =3 $\Omega$ | -   | 6    | -    | nS   |
| Turn-on Rise Time                  | t <sub>r</sub>      |   | -   | 7    | -    | nS   |
| Turn-Off Delay Time                | t <sub>d(off)</sub> |   | -   | 15   | -    | nS   |
| Turn-Off Fall Time                 | t <sub>f</sub>      |   | -   | 4    | -    | nS   |
| Total Gate Charge                  | Qg                  | V <sub>DS</sub> =125V,I <sub>D</sub> =15A,                                | -   | 17.9 | -    | nC   |
| Gate-Source Charge                 | Q <sub>gs</sub>     |   | -   | 6.7  | -    | nC   |
| Gate-Drain Charge                  | Q <sub>gd</sub>     | V <sub>GS</sub> =10V  | -   | 5    | -    | nC   |
| Drain-Source Diode Characteristics |                     |   | •   | •    |      | •    |
| Diode Forward Voltage (Note 3)     | V <sub>SD</sub>     | V <sub>GS</sub> =0V,I <sub>S</sub> =15A                                   | -   | -    | 1.2  | V    |
| Diode Forward Current (Note 2)     | Is                  |   | -   | -    | 15   | Α    |
| Reverse Recovery Time              | t <sub>rr</sub>     | $T_J = 25^{\circ}C, I_F = I_S$  | -   | 30   | -    | nS   |
| Reverse Recovery Charge            | Qrr                 | $di/dt = 100A/\mu s^{(Note3)}$  | -   | 125  | -    | nC   |

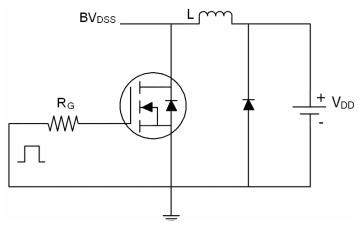
#### Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t  $\leq$  10 sec.
- 3. Pulse Test: Pulse Width  $\leq$  300 $\mu$ s, Duty Cycle  $\leq$  2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25  $^{\circ}\text{C}$  ,V\_DD=50V,V\_G=10V,L=0.5mH,Rg=25 $\Omega$

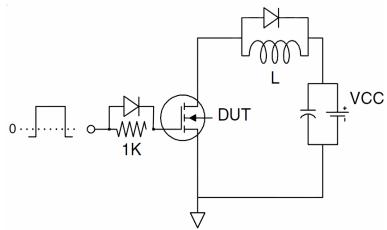


### **Test Circuit**

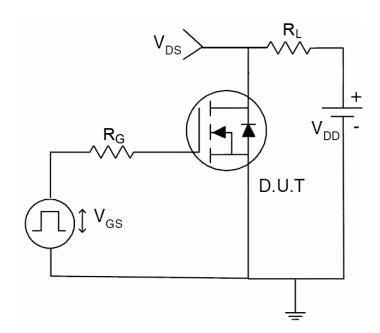
# 1) E<sub>AS</sub> test Circuit



## 2) Gate charge test Circuit

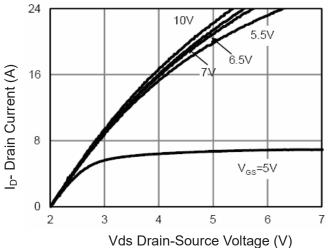


## 3) Switch Time Test Circuit

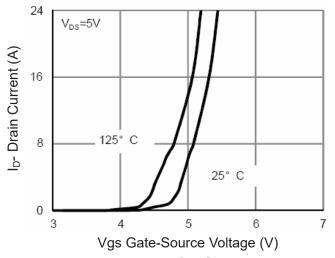








**Figure 1 Output Characteristics** 



**Figure 2 Transfer Characteristics** 

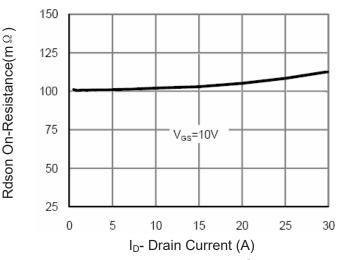


Figure 3 Rdson- Drain Current

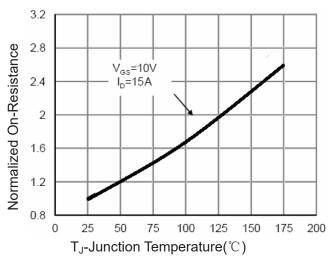


Figure 4 Rdson-Junction Temperature

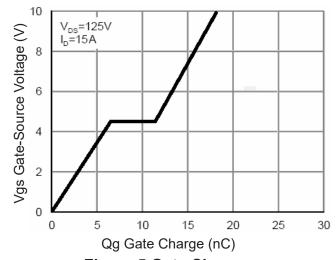


Figure 5 Gate Charge

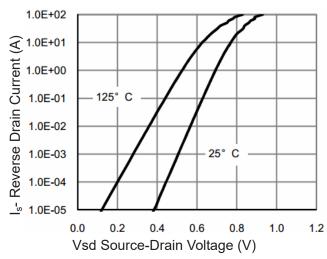
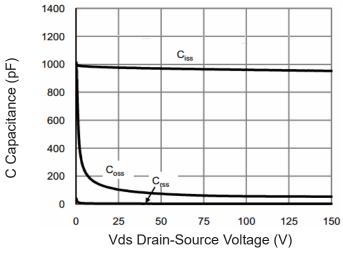


Figure 6 Source- Drain Diode Forward



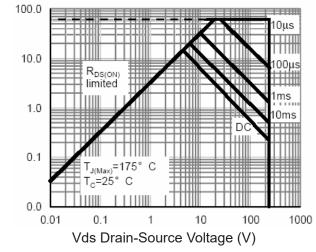
Ip- Drain Current (A)



40

Figure 7 Capacitance vs Vds

Figure 9 Power De-rating



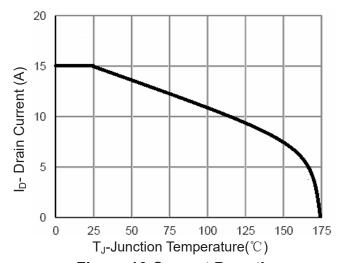
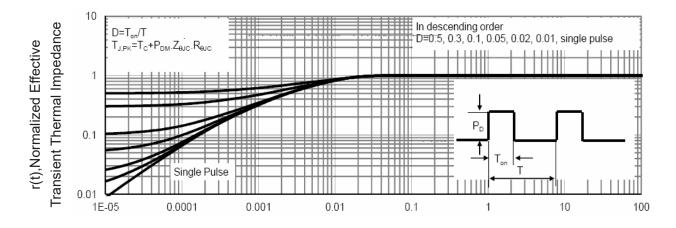


Figure 8 Safe Operation Area

Figure 10 Current De-rating



Square Wave Pluse Duration(sec)

**Figure 11 Normalized Maximum Transient Thermal Impedance**